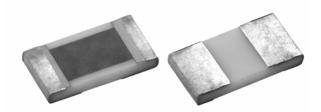


Vishay Thin Film

High Power Thin Film Wraparound Chip Resistor



PHP series chip resistors are designed with enlarged backside terminations to reduce the thermal resistance between the topside resistor layer and the solder joint on the end users circuit board.

Actual power handling capability is limited by the end user mounting process. As with any high power chip resistor the ability to remove the generated heat is critical to the overall performance of the device.

FEATURES

- High purity ceramic substrate
- Power rating to 2.5 W
- Resistance range 10 Ω to 30 k Ω
- Resistor tolerance to ± 0.1 %
- TCR to ± 25 ppm/°C
- Flame resistant UL 94 V-0

APPLICATIONS

- Power supplies
- Power switching
- Braking system
- Test and measurement equipment
- Motor deflection circuits

TYPICAL PERFORMANCE

	ABSOLUTE	
TCR	25	
TOL.	0.1	

STANDARD ELECTRICAL SPECIFICATIONS			
TEST	SPECIFICATIONS	CONDITIONS	
Material	Nichrome	-	
Resistance Range	10 Ω to 30 kΩ	-	
TCR: Absolute	25 ppm/°C, 50 ppm/°C (stdandard) and 100 ppm/°C	- 55 °C to + 125 °C	
Tolerance: Absolute	0.1 %, 0.5 %, 1.0 % and 5.0 %	+ 25 °C	
Power Rating: Resistor	1206: 1.0 W, 2512: 2.5 W ⁽¹⁾	Maximum at + 70 °C	
Stability: Absolute	∆R 0.1 %	2000 h at + 70 °C	
Stability: Ratio	Not applicable	-	
Voltage Coefficient	< 0.1 ppm/V	-	
Working Voltage	1206: 100 V, 2512: 200 V	-	
Operating Temperature Range	- 55 °C to + 125 °C	-	
Storage Temperature Range	- 55 °C to + 150 °C	-	
Noise	< - 30 dB	-	
Shelf Life Stability: Absolute	± 0.01 %	1 year at + 25 °C	

COMPONENT RATINGS CASE SIZE POWER RATING (mW) WORKING VOLTAGE (V) RESISTANCE RANGE (Ω) 1206 1000 ⁽¹⁾ 100 10 to 30K 2512 2500 ⁽¹⁾ 200 10 to 30K

Note

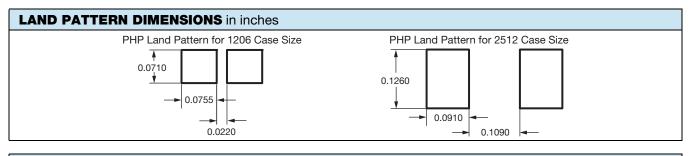
⁽¹⁾ Dependent on component mounting by user

ENVIRONMENTAL TESTS (Vishay Performance vs. MIL-PRF-55342 Requirements)				
ENVIRONMENTAL TEST	LIMITS MIL-PRF-55342 CHARACTERISTIC "E"	TYPICAL VISHAY PERFORMANCE		
Resistance Temperature Characteristic	± 25 ppm/°C	± 15 ppm/°C		
Maximum Ambient Temperature at Rated Wattage	+ 70 °C	+ 70 °C		
Maximum Ambient Temperature at Power Derating	+ 150 °C	+ 150 °C		
Thermal Shock	± 0.1 %	± 0.04 %		
Low Temperature Operation	± 0.1 %	± 0.001 %		
Short Time Overload	± 0.1 %	± 0.003 %		
High Temperature Exposure	± 0.1 %	± 0.030 %		
Resistance to Soldering Heat	± 0.2 %	± 0.007 %		
Moisture Resistance	± 0.2 %	± 0.002 %		
Life at + 70 °C for 2000 h	± 0.5 %	± 0.100 %		

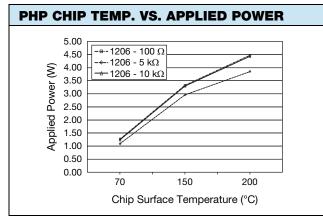
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DIMENSIONS in inches					
CASE SIZE	LENGTH	WIDTH W (± 0.005)	THICKNESS MIN./MAX.	TOP PAD D (± 0.005)	BOTTOM PAD E (± 0.005)
1206	0.126 ± 0.008	0.063	0.015/0.033	0.020 + 0.005/- 0.010	0.040
2512	0.259 + 0.009/- 0.015	0.124	0.015/0.033	0.02	0.050

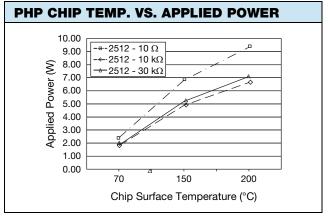


STANDARD MATERIAL SPECIFICATIONS		
Resistive Element Nichrome		
Substrate Material	Alumina (Al ₂ O ₃)	
Terminations (Tin/Lead)	Tin/lead solder over nickel barrier	
Terminations (Lead (Pb)-free)	Tin/silver/copper (Sn96.5Ag3.0Cu0.5) solder over nickel barrier	



Notes

- Chip surface temperature measured using FLIR A40 thermal imaging system with an approximate test card surface temperature of 85 °C.
- Thermal imaging was conducted under ambient conditions resulting in a steady state test card surface temperature of 85 °C over the full range of power levels.
- Thermal imaging and load life testing was conducted mounting one device to 2" x 3" test cards with 2.5 mil copper plating on both surfaces. Thermal vias on 120 mil centers were utilized for heat transfer between surfaces of the test card.



Notes

 Chip surface temperature measured using FLIR A40 thermal imaging system with an approximate test card surface temperature of 85 °C.

Case Size	2512	2512	2512	
Resistance Value	Up to 10 Ω	ο 10 Ω Up to 10 kΩ Up to 3		
Temperature	Power (W)			
70	2.44	1.81	1.87	
150	6.82	4.89	5.19	
200	9.33	6.63	7.09	



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GLOBAL PART NUMBER		ΓΙΟΝ			
	1 2	0 6		0 0 2 B	
MODEL SUBSTRATE SIZE	TCR	RESISTANCE	TOLERANCE	TERMINATION	PACKAGING
PHP 0 = Alumina 1206 2512	E = ± 25 ppm/°C H = ± 50 ppm/°C K = ± 100 ppm/°C	The first 3 digits are significant figures and the last digit specifies the number of zeros to follow. "R" designates the decimal point. Example: $10R0 = 10 \Omega$ $1000 = 100 \Omega$ $1001 = 1 k\Omega$	$B = \pm 0.1 \%$ $D = \pm 0.5 \%$ $F = \pm 1.0 \%$ $G = \pm 2.0 \%$ $J = \pm 5.0 \%$	 B = Wraparound Sn/Pb solder w/nickel barrier S = Wraparound lead (Pb)-free solder SAC-305 RoHS compliant - e1 	BS = BULK 100 min., 1 mult $WS = WAFFLE$ 100 min., 1 mult $WI = WAFFLE$ (item single lot day code) 100 min., 1 mult $TAPE AND REEL$ $T1 = 1000 min., 1 mult$ $TF = Full reel$ $TS = 100 min., 1 mult$ $II = 100 min., 1 mult$ (item single lot date code) $TP = 100 min., 1 mult$ (package unit single lot date)



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